Study on structure-property relationship of polyimide blends

I. A dynamic mechanical study of the miscibility of polyimide/polyimide blends

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Summary

Three pairs of polyimide/polyimide blends (50/50 wt%) with different molecular structures were prepared by two ways, i.e. mixing of the polyamic acid precursors with subsequent imidization, and direct solution mixing of the polyimides. The blends were studied with DMA technique. The results obtained show that two different all the blends prepared with these ways are as there existed only one glass transition temperamiscible. for all the blends. Tt. is suggested that the ture(Tg) miscibility of these polyimide/polyimide blends is a result of the strong inter-molecular charge-transfer interaction between the chains of their components.

Introduction

Polyimides(PIs) constitute the biggest and most popular Because of the availabifamily of high temperature polymers. lity of certain monomers, more PIs with different structures have been synthesized. However, it is quite difficult to make one kind of PI possess all the functions demanded. On the other hand, fundamental studies of the phase states of blends of have been remarkedly advanced. Hence, in polymers different recent years, a number of novel polymer blends based on PI have been developed and used in various fields. It has been reported that various PIs are miscible with PBI(1-6), PEEK(7), PES(8), and mechanism of miscibility sulfonated PEEK(9). Although the of PBI/PIs was shown to be related to H-bonding between the chains of the two components, the mechanism of other blends is not yet clear.It has been shown that most soluble PI chains are very flexible, and the high thermal stability and outstanding mechanical property of PIs are due to their strong inter- or intra-molecular charge-transfer interaction between groups in the chains(10, 11). imide groups and aromatic Therefore, we consider, the mechanism of miscible blends of PIs with PEEK, PES, and sulfonated PEEK may be due to the interaction between imide groups in PI chains with the aromatic of the other polymers. From the above the chains groups in point of view, it may be expected that two different PIs having electron-donor and electron-aceptor in their chains respectively should have much more opportunity to form intermolecular interaction between the chains of charge-transfer

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different kinds, which might lead to the formation of miscible or semi-miscible blends. This is the purpose of our investigation.

Experimental

Preparation of blend specimens

The polyimide blends were prepared in two ways. In the first way, the PI blends were obtained by solution blending of two PI precusors, i. e. polyamic acids, in DMF with a concentration of 15%(wt/v) at room temperature. Film specimens were produced by casting the solution onto a glass plate, drying at 40°C for 16 hours, then transfered into a vacuum oven, maintained at 100°C for 3 hours, and afterwards heated to 280°C in about 3 hours. In the second way, the blends were prepared directly by solution blending of two polyimides in m-crosel, followed by precipitation in ethanol, filtration and drying.

The binary blends of PIs studied included PEI-E/PTI-E, PEI-E/PSI-E and PTI-E/PTI(3,3)-E, the composition of which were 50/50 by weight. The molecular structure and glass transition temperatures(Tg) of these PIs are as follows. Meanwhile, the inherent viscosities(ni) of PIs used in solution blending experiment measured at 30°C in 0.5 wt% m-cresol are also given.



Dynamic mechanical analysis (DMA)

DMA was carried out with a DuPont 982 DMA at a heating rate of 5°C/min from room temperature to 400°C. The PI specimens used for DMA were 2mm thick, compression molded at 370°C, cooled to 200°C in press, and then guenched with water.

Results and Discussion

The films of polyamic acid blends drying at 40°C prepared by the first way were clear and transparent. However, after imidization at 280°C, the films were still transparent, but their color changed to pale yellow or reddish-brown. This result implies that these PI blends prepared by the first way are miscible.

In order to confirm the above phenomenon. the DMA study for PEI-E/PTI-E and PEI-E/PSI-E blends. the was carried out results of which are shown in Fig.1 and 2 respectively. It is clearly shown that there exist two relaxation peaks, α and β , in the the blends as well as in their components. The a relaxation is the glass transition, while the β relaxation is related to the motion of aromatic and benzimide rings(10, 12). For both blends, a single, sharp glass transition located in between the two Tgs of its components, confirms that these blends completely miscible. The location of the β two are relaxation of the blends being in between the β two relaxations of their component PIs might be operated by the same mechanism. both interchain and intrachain barriers, 85 suggested in the literature(7).



PEI-E/PTI-E=50/50



The prepration of polyimide blends obtained by solution mixing of polyamic acid precursors and subsequent solid state imidization was reported by Yokota et al (13), but the structure of the blends are rather complicated due to the exchange reactions between polyamic acids solution and during the in Feger considered \mathbf{at} imidization process. that storge room temperature and slow curing of polyamic acid blends lead to copolymerization (14).

In our preparation of the blends by the first way, copolymerization may also take place, hence if any copolymer produced will have certain influence on the miscibility.

In order to reveal the influence of copolymerization on the miscibility, the blends of PEI-E/PSI-E and PTI-E/PTI(3,3)-E with a composition of 50/50 were prepared directly by solution blending in m-cresol(the second way), during which copolymerization should not occur.

The DMA curves of PTI-E/PTI(3,3)-E, and PEI-E/PSI-E are Fig.3 and 4 respectively. The existance of only a shown in single Tg for all the blends confirms the miscibility of these two pairs of PIs, which also shows that the two different ways of blending used in this work do not affect their miscibility. However, it should be noted that the position, height and broadness of the three Tg peaks are different by different ways of blending and after treatments(Fig.4). The one by direct solution blending has a much broader but less high glass transition than those of the blends prepared by the first way. which implies that the copolymerization occured in the process acids in solution of mixing polyamic could improve the miscibility of the blends on molecular level. Meanwhile, it is also noted that the blends stored with different lengths of time after blending by the first way show different relaxation properties in their modulus and transition temperature, which could be partly explained by the result of copolymerization, but other factors are still to be sought for (14).









Conclusion

the above results, it may be concluded that binary From polyimides with different molecular structures are blends of miscible due to the strong intermolecular charge-transfer interaction between imide groups and aromatic groups in the chains of their components, since there is no other factor which could play the role of increasing the interaction between two polyimides' chains.

The two methods, used in this work for blending have not much different effects on the miscibility of polyimide pairs as a whole, although direct blending might give some what higher microheterogeneity in the blends. The first way of blending is in favor of obtaining a more even mixture, as indicated by a sharp, narrow and high Tg peak, which might due its more complicated structure resulted from exchange to copolymerization during curing and storage. The reaction or study of its mechanism is in progress.

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